



**THE DATASHEET OF
ADUM142D1BRWZ-RL**



FEATURES

High common-mode transient immunity: 100 kV/μs

High robustness to radiated and conducted noise

Low propagation delay

13 ns maximum for 5 V operation

15 ns maximum for 1.8 V operation

150 Mbps maximum guaranteed data rate

Safety and regulatory approvals

UL recognition

3000 V rms/3750 V rms for 1 minute per UL 1577

CSA Component Acceptance Notice 5A

VDE certificate of conformity

DIN V VDE V 0884-11 (VDE V 0884-11):2017-01

$V_{IORM} = 849$ V peak

CQC certification per GB4943.1-2011

Backward compatibility

ADuM140E1/ADuM141E1/ADuM142E1 pin-compatible
with **ADuM1400/ADuM1401/ADuM1402**

Low dynamic power consumption

1.8 V to 5 V level translation

High temperature operation: 125°C

Fail-safe high or low options

16-lead, RoHS compliant, SOIC package

Qualified for automotive applications

APPLICATIONS

General-purpose multichannel isolation

Serial peripheral interface (SPI)/data converter isolation

Industrial field bus isolation

GENERAL DESCRIPTION

The **ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E**¹ are quad-channel digital isolators based on Analog Devices, Inc., *iCoupler*® technology. Combining high speed, complementary metal-oxide semiconductor (CMOS) and monolithic air core transformer technology, these isolation components provide outstanding performance characteristics superior to alternatives such as optocoupler devices and other integrated couplers. The maximum propagation delay is 13 ns with a pulse width distortion of less than 3 ns at 5 V operation. Channel matching is tight at 3.0 ns maximum.

The **ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E** data channels are independent and are available in a variety of configurations with a withstand voltage rating of 3.0 kV rms or 3.75 kV rms (see the Ordering Guide). The devices operate with the supply voltage on either side ranging from 1.8 V to 5 V, providing compatibility with lower voltage systems as well as enabling voltage translation

Rev. J

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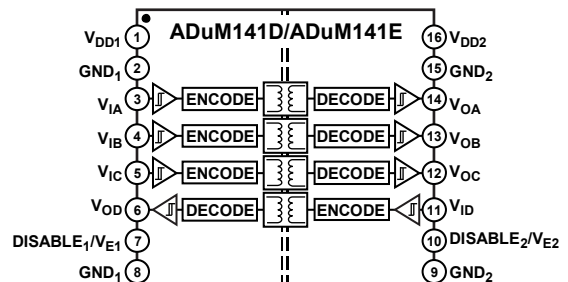
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FUNCTIONAL BLOCK DIAGRAMS



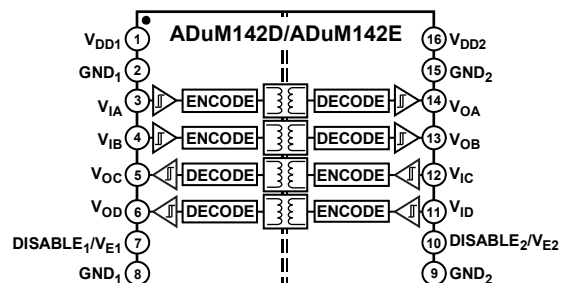
- NOTES
1. NIC = NO INTERNAL CONNECTION. LEAVE THIS PIN FLOATING.
 2. PIN 7 IS DISABLE₁ AND PIN 10 IS NIC FOR THE ADuM140D, AND PIN 7 IS NIC AND PIN 10 IS VE₂ FOR THE ADuM140E.

Figure 1. ADuM140D/ADuM140E Functional Block Diagram



- NOTES
1. PIN 7 IS DISABLE₁ AND PIN 10 IS DISABLE₂ FOR THE ADuM141D, AND PIN 7 IS VE₁ AND PIN 10 IS VE₂ FOR THE ADuM141E.

Figure 2. ADuM141D/ADuM141E Functional Block Diagram



- NOTES
1. PIN 7 IS DISABLE₁ AND PIN 10 IS DISABLE₂ FOR THE ADuM142D, AND PIN 7 IS VE₁ AND PIN 10 IS VE₂ FOR THE ADuM142E.

Figure 3. ADuM142D/ADuM142E Functional Block Diagram

functionality across the isolation barrier.

Unlike other optocoupler alternatives, dc correctness is ensured in the absence of input logic transitions. Two different fail-safe options are available, by which the outputs transition to a pre-determined state when the input power supply is not applied or the inputs are disabled. The **ADuM140E1/ADuM141E1/ADuM142E1** are pin-compatible with the **ADuM1400/ADuM1401/ADuM1402**.

¹ Protected by U.S. Patents 5,952,849; 6,873,065; 6,903,578; and 7,075,329. Other patents are pending.

TABLE OF CONTENTS

Features	1	Absolute Maximum Ratings	17
Applications	1	ESD Caution	17
General Description	1	Truth Tables.....	18
Functional Block Diagrams.....	1	Pin Configurations and Function Descriptions.....	19
Revision History	3	Typical Performance Characteristics	22
Specifications	4	Applications Information	24
Electrical Characteristics—5 V Operation.....	4	Overview.....	24
Electrical Characteristics—3.3 V Operation	6	Printed Circuit Board (PCB) Layout.....	24
Electrical Characteristics—2.5 V Operation	8	Propagation Delay Related Parameters.....	25
Electrical Characteristics—1.8 V Operation	10	Jitter Measurement	25
Insulation and Safety Related Specifications.....	12	Insulation Lifetime.....	25
Package Characteristics	12	Outline Dimensions.....	27
Regulatory Information.....	13	Ordering Guide	28
DIN V VDE V 0884-11 (VDE V 0884-11) Insulation		Automotive Products	30
Characteristics	14		
Recommended Operating Conditions	16		

REVISION HISTORY**7/2020—Rev. I to Rev. J**

Changed DIN V VDE V 0884-10 to DIN V VDE V 0884-11	Universal
Change to Features Section	1
Changes to Table 13 and Table 14	13
Changes to Table 15 and Table 16	14
Changes to Table 17 and Table 18	15
Changes to Figure 6	16
Changes to Table 20	17
Changes to Ordering Guide	29

8/2018—Rev. H to Rev. I

Changes to Table 13	13
Changes to Table 15	14
Changes to Ordering Guide	28
Change to Automotive Products Section	30

12/2017—Rev. G to Rev. H

Changes to Ordering Guide	28
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7/2017—Rev. F to Rev. G

Changes to Ordering Guide	28
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6/2017—Rev. E to Rev. F

Changes to Ordering Guide	28
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2/2017—Rev. D to Rev. E

Added RQ-16 Package	Universal
Added Table 11; Renumbered Sequentially	12
Changes to Table 12	12
Changes to Table 13 and Table 14	13
Added Table 15	14
Added Table 18	15
Added Figure 6; Renumbered Sequentially	16
Added Table 23	18
Added Figure 29	28
Updated Outline Dimensions	28
Changes to Ordering Guide	28
Changes to Automotive Products Section	29

10/2016—Rev. C to Rev. D

Changes to Features Section	1
Changes to Table 12 and Table 13	12

4/2016—Rev. B to Rev. C

Changes to Features Section	1
Changes to Ordering Guide	26
Added Automotive Products Section	27

11/2015—Rev. A to Rev. B

Added 16-Lead, Narrow Body SOIC Package	Universal
Changes to Title, Features Section, and General Description Section	1
Changes to Table 1	3
Changes to Table 3	5
Changes to Table 5	7
Changes to Table 7	9
Added Table 9; Renumbered Sequentially	11
Changes to Table 10 and Table 11	11
Changes to Regulator Information Section	12
Changes to Table 12	12
Added Table 13	12
Changes to Table 14	13
Added Table 15 and Figure 4; Renumbered Sequentially	14
Changes to Figure 5 Caption	14
Changes to Endnote 3, Table 17, and Table 19 Title	15
Added Table 18	15
Changes to Surface Tracking Section	23
Changes to Calculation and Use of Parameters Example Section	24
Updated Outline Dimensions	25
Changes to Ordering Guide	26

9/2015—Rev. 0 to Rev. A

Added ADuM141D/ADuM141E	Universal
Added ADuM142D/ADuM142E	Universal
Changes to Features and Figure 1	1
Delete Figure 2; Renumbered Sequentially	1
Added Figure 2 and Figure 3; Renumbered Sequentially	1
Changes to Table 1	3
Changes to Table 2	4
Changes to Table 3	5
Changes to Table 4	6
Changes to Table 5	7
Change to Table 6	8
Changes to Table 7	9
Changes to Table 8	10
Changes to Table 11	11
Changes to Table 12	12
Changes Table 15	13
Changes to Table 17	14
Added Figure 7, Figure 8, and Table 19; Renumbered Sequentially	16
Added Figure 9, Figure 10, and Table 20	16
Added Figure 13 and Figure 16	18
Changes to Figure 17 and Figure 18	19
Changes to Overview Section and Figure 19	20
Updated Outline Dimensions	23
Changes to Ordering Guide	23

4/2015—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range of $4.5\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$, $4.5\text{ V} \leq V_{DD2} \leq 5.5\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 1.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within pulse width distortion (PWD) limit
Data Rate ¹		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	4.8	7.2	13	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.5	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/°C	
Propagation Delay Skew	t_{PSK}			6.1	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.5	3.0	ns	
Opposing Direction	t_{PSKOD}		0.5	3.0	ns	
Jitter			490		ps p-p	See the Jitter Measurement section
			70		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold Voltage						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^2 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^3$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^2 = -4\ \text{mA}$, $V_{Ix} = V_{IxH}^3$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^2 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^4$
			0.2	0.4	V	$I_{Ox}^2 = 4\ \text{mA}$, $V_{Ix} = V_{IxL}^4$
Input Current per Channel	I_i	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
V_{E2} Enable Input Pull-Up Current	I_{PU}	-10	-3		μA	$V_{E2} = 0\text{ V}$
DISABLE ₁ Input Pull-Down Current	I_{PD}		9	15	μA	DISABLE ₁ = V_{DDx}
Tristate Output Current per Channel	I_{OZ}	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ox} \leq V_{DDx}$
Quiescent Supply Current						
ADuM140D/ADuM140E						
	$I_{DD1(Q)}$		1.2	2.2	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.72	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		12.0	20.0	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.92	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
ADuM141D/ADuM141E						
	$I_{DD1(Q)}$		1.6	2.46	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.9	2.62	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		10.0	17.0	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		6.0	10.0	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
ADuM142D/ADuM142E						
	$I_{DD1(Q)}$		1.6	2.46	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.6	2.46	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		7.2	11.5	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		8.4	11.5	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Dynamic Supply Current						
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Dynamic Output	$I_{DDO(D)}$		0.02		mA/Mbps	Inputs switching, 50% duty cycle
Undervoltage Lockout	UVLO					
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁷	$ CM_H $	75	100		kV/ μ s	$V_{IX} = V_{DDx}$, $V_{CM} = 1000$ V, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μ s	$V_{IX} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{Ox} is the Channel x output current, where x = A, B, C, or D.

³ V_{IH} is the input side logic high.

⁴ V_{IL} is the input side logic low.

⁵ V_I is the voltage input.

⁶ E0 is the ADuM140E0/ADuM141E0/ADuM142E0 models, D0 is the ADuM140D0/ADuM141D0/ADuM142D0 models, E1 is the ADuM140E1/ADuM141E1/ADuM142E1 models, and D1 is the ADuM140D1/ADuM141D1/ADuM142D1 models. See the Ordering Guide section.

⁷ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_O) > 0.8 V_{DDx} . $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 2. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM140D/ADuM140E											
Supply Current Side 1	I_{DD1}		6.8	10		7.8	12		11.8	17.4	mA
Supply Current Side 2	I_{DD2}		2.1	3.7		3.9	5.7		9.2	13	mA
ADuM141D/ADuM141E											
Supply Current Side 1	I_{DD1}		5.8	10.3		7.0	10.9		11.4	15.9	mA
Supply Current Side 2	I_{DD2}		4.0	6.85		5.5	8.5		10.3	14.0	mA
ADuM142D/ADuM142E											
Supply Current Side 1	I_{DD1}		4.3	7.7		6.0	9.3		10.3	14.2	mA
Supply Current Side 2	I_{DD2}		5.3	8.7		6.7	10.1		11.0	14.9	mA

ELECTRICAL CHARACTERISTICS—3.3 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 3.3\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $3.0\text{ V} \leq V_{DD1} \leq 3.6\text{ V}$, $3.0\text{ V} \leq V_{DD2} \leq 3.6\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 3.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within PWD limit
Data Rate ¹		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	4.8	6.8	14	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.7	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/°C	
Propagation Delay Skew	t_{PSK}			7.5	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.7	3.0	ns	
Opposing Direction	t_{PSKOD}		0.7	3.0	ns	
Jitter			580		ps p-p	See the Jitter Measurement section
			120		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold Voltage						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^2 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^3$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^2 = -2\ \text{mA}$, $V_{Ix} = V_{IxH}^3$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^2 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^4$
			0.2	0.4	V	$I_{Ox}^2 = 2\ \text{mA}$, $V_{Ix} = V_{IxL}^4$
Input Current per Channel	I_i	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
V_{E2} Enable Input Pull-Up Current	I_{PU}	-10	-3		μA	$V_{E2} = 0\text{ V}$
DISABLE ₁ Input Pull-Down Current	I_{PD}		9	15	μA	DISABLE ₁ = V_{DDx}
Tristate Output Current per Channel	I_{OZ}	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ox} \leq V_{DDx}$
Quiescent Supply Current						
ADuM140D/ADuM140E						
	$I_{DD1(Q)}$		1.2	2.12	mA	$V_i^5 = 0\text{ (E0, D0)}$, 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.68	mA	$V_i^5 = 0\text{ (E0, D0)}$, 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		12.0	19.6	mA	$V_i^5 = 1\text{ (E0, D0)}$, 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.8	mA	$V_i^5 = 1\text{ (E0, D0)}$, 0 (E1, D1) ⁶
ADuM141D/ADuM141E						
	$I_{DD1(Q)}$		1.5	2.36	mA	$V_i^5 = 0\text{ (E0, D0)}$, 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.8	2.52	mA	$V_i^5 = 0\text{ (E0, D0)}$, 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		9.8	16.7	mA	$V_i^5 = 1\text{ (E0, D0)}$, 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		5.7	9.7	mA	$V_i^5 = 1\text{ (E0, D0)}$, 0 (E1, D1) ⁶
ADuM142D/ADuM142E						
	$I_{DD1(Q)}$		1.6	2.4	mA	$V_i^5 = 0\text{ (E0, D0)}$, 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.6	2.4	mA	$V_i^5 = 0\text{ (E0, D0)}$, 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		7.2	11.2	mA	$V_i^5 = 1\text{ (E0, D0)}$, 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		8.4	11.2	mA	$V_i^5 = 1\text{ (E0, D0)}$, 0 (E1, D1) ⁶

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Dynamic Supply Current						
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Dynamic Output	$I_{DDO(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Undervoltage Lockout	UVLO					
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_r/t_f		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁷	$ CM_H $	75	100		kV/ μ s	$V_{ix} = V_{DDx}$, $V_{CM} = 1000$ V, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μ s	$V_{ix} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{Ox} is the Channel x output current, where x = A, B, C, or D.

³ V_{IH} is the input side logic high.

⁴ V_{IL} is the input side logic low.

⁵ V_i is the voltage input.

⁶ E0 is the ADuM140E0/ADuM141E0/ADuM142E0 models, D0 is the ADuM140D0/ADuM141D0/ADuM142D0 models, E1 is the ADuM140E1/ADuM141E1/ADuM142E1 models, and D1 is the ADuM140D1/ADuM141D1/ADuM142D1 models. See the Ordering Guide section.

⁷ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (V_O) > 0.8 V_{DDx} . $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 4. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM140D/ADuM140E											
Supply Current Side 1	I_{DD1}		6.6	9.8		7.4	11.2		10.7	15.9	mA
Supply Current Side 2	I_{DD2}		2.0	3.7		3.5	5.5		8.2	11.6	mA
ADuM141D/ADuM141E											
Supply Current Side 1	I_{DD1}		5.65	10.1		6.65	10.5		10.4	14.9	mA
Supply Current Side 2	I_{DD2}		3.9	6.65		5.2	8.0		9.4	12.8	mA
ADuM142D/ADuM142E											
Supply Current Side 1	I_{DD1}		4.3	7.7		5.6	9.0		9.1	13	mA
Supply Current Side 2	I_{DD2}		5.0	8.4		6.2	9.6		9.8	13.7	mA

ELECTRICAL CHARACTERISTICS—2.5 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 2.5\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $2.25\text{ V} \leq V_{DD1} \leq 2.75\text{ V}$, $2.25\text{ V} \leq V_{DD2} \leq 2.75\text{ V}$, $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 5.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within PWD limit
Data Rate ¹		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	5.0	7.0	14	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.7	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/°C	
Propagation Delay Skew	t_{PSK}			6.8	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.7	3.0	ns	
Opposing Direction	t_{PSKOD}		0.7	3.0	ns	
Jitter			800		ps p-p	See the Jitter Measurement section
			190		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold Voltage						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^2 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^3$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^2 = -2\ \text{mA}$, $V_{Ix} = V_{IxH}^3$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^2 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^4$
			0.2	0.4	V	$I_{Ox}^2 = 2\ \text{mA}$, $V_{Ix} = V_{IxL}^4$
Input Current per Channel	I_i	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
V_{E2} Enable Input Pull-Up Current	I_{PU}	-10	-3		μA	$V_{E2} = 0\text{ V}$
DISABLE ₁ Input Pull-Down Current	I_{PD}		9	15	μA	DISABLE ₁ = V_{DDx}
Tristate Output Current per Channel	I_{OZ}	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ox} \leq V_{DDx}$
Quiescent Supply Current						
ADuM140D/ADuM140E						
	$I_{DD1(Q)}$		1.2	2.0	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.64	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		1.2	19.6	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.76	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
ADuM141D/ADuM141E						
	$I_{DD1(Q)}$		1.46	2.32	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.75	2.47	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		9.7	16.6	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		5.67	9.67	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
ADuM142D/ADuM142E						
	$I_{DD1(Q)}$		1.6	2.32	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.6	2.32	mA	$V_i^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		7.2	11.2	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		8.4	11.2	mA	$V_i^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
Dynamic Supply Current						
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Dynamic Output	$I_{DDO(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Undervoltage Lockout						
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁷	$ CM_H $	75	100		kV/ μ s	$V_{ix} = V_{DDx}$, $V_{CM} = 1000$ V, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μ s	$V_{ix} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{Ox} is the Channel x output current, where x = A, B, C, or D.

³ V_{IH} is the input side logic high.

⁴ V_{IL} is the input side logic low.

⁵ V_i is the voltage input.

⁶ E0 is the ADuM140E0/ADuM141E0/ADuM142E0 models, D0 is the ADuM140D0/ADuM141D0/ADuM142D0 models, E1 is the ADuM140E1/ADuM141E1/ADuM142E1 models, and D1 is the ADuM140D1/ADuM141D1/ADuM142D1 models. See the Ordering Guide section.

⁷ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining the voltage output (VO) > 0.8 VDDx. $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 6. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM140D/ADuM140E											
Supply Current Side 1	I_{DD1}		6.5	9.8		7.3	11.1		10.4	15.5	mA
Supply Current Side 2	I_{DD2}		2.0	3.6		3.3	5.2		7.3	10.2	mA
ADuM141D/ADuM141E											
Supply Current Side 1	I_{DD1}		5.6	10.0		6.4	10.4		9.7	14.5	mA
Supply Current Side 2	I_{DD2}		3.8	6.55		4.8	7.7		8.3	11.5	mA
ADuM142D/ADuM142E											
Supply Current Side 1	I_{DD1}		4.3	7.7		5.4	8.8		8.8	12.7	mA
Supply Current Side 2	I_{DD2}		5.0	8.4		6.1	9.5		9.5	13.4	mA

ELECTRICAL CHARACTERISTICS—1.8 V OPERATION

All typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = V_{DD2} = 1.8\text{ V}$. Minimum/maximum specifications apply over the entire recommended operation range: $1.7\text{ V} \leq V_{DD1} \leq 1.9\text{ V}$, $1.7\text{ V} \leq V_{DD2} \leq 1.9\text{ V}$, and $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$, unless otherwise noted. Switching specifications are tested with $C_L = 15\text{ pF}$ and CMOS signal levels, unless otherwise noted. Supply currents are specified with 50% duty cycle signals.

Table 7.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
SWITCHING SPECIFICATIONS						
Pulse Width	PW	6.6			ns	Within PWD limit
Data Rate ¹		150			Mbps	Within PWD limit
Propagation Delay	t_{PHL} , t_{PLH}	5.8	8.7	15	ns	50% input to 50% output
Pulse Width Distortion	PWD		0.7	3	ns	$ t_{PLH} - t_{PHL} $
Change vs. Temperature			1.5		ps/°C	
Propagation Delay Skew	t_{PSK}			7.0	ns	Between any two units at the same temperature, voltage, and load
Channel Matching						
Codirectional	t_{PSKCD}		0.7	3.0	ns	
Opposing Direction	t_{PSKOD}		0.7	3.0	ns	
Jitter			470		ps p-p	See the Jitter Measurement section
			70		ps rms	See the Jitter Measurement section
DC SPECIFICATIONS						
Input Threshold Voltage						
Logic High	V_{IH}	$0.7 \times V_{DDx}$			V	
Logic Low	V_{IL}			$0.3 \times V_{DDx}$	V	
Output Voltage						
Logic High	V_{OH}	$V_{DDx} - 0.1$	V_{DDx}		V	$I_{Ox}^2 = -20\ \mu\text{A}$, $V_{Ix} = V_{IxH}^3$
		$V_{DDx} - 0.4$	$V_{DDx} - 0.2$		V	$I_{Ox}^2 = -2\ \text{mA}$, $V_{Ix} = V_{IxH}^3$
Logic Low	V_{OL}		0.0	0.1	V	$I_{Ox}^2 = 20\ \mu\text{A}$, $V_{Ix} = V_{IxL}^4$
			0.2	0.4	V	$I_{Ox}^2 = 2\ \text{mA}$, $V_{Ix} = V_{IxL}^4$
Input Current per Channel	I_i	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ix} \leq V_{DDx}$
V_{E2} Enable Input Pull-Up Current	I_{PU}	-10	-3		μA	$V_{E2} = 0\text{ V}$
DISABLE ₁ Input Pull-Down Current	I_{PD}		9	15	μA	DISABLE ₁ = V_{DDx}
Tristate Output Current per Channel	I_{OZ}	-10	+0.01	+10	μA	$0\text{ V} \leq V_{Ox} \leq V_{DDx}$
Quiescent Supply Current						
ADuM140D/ADuM140E						
	$I_{DD1(Q)}$		1.2	1.92	mA	$V_I^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.64	mA	$V_I^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		12.0	19.6	mA	$V_I^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		2.0	2.76	mA	$V_I^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
ADuM141D/ADuM141E						
	$I_{DD1(Q)}$		1.4	2.28	mA	$V_I^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.73	2.45	mA	$V_I^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		9.6	16.5	mA	$V_I^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		5.6	9.6	mA	$V_I^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
ADuM142D/ADuM142E						
	$I_{DD1(Q)}$		1.6	2.28	mA	$V_I^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD2(Q)}$		1.6	2.28	mA	$V_I^5 = 0$ (E0, D0), 1 (E1, D1) ⁶
	$I_{DD1(Q)}$		7.2	11.2	mA	$V_I^5 = 1$ (E0, D0), 0 (E1, D1) ⁶
	$I_{DD2(Q)}$		8.4	11.2	mA	$V_I^5 = 1$ (E0, D0), 0 (E1, D1) ⁶

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Dynamic Supply Current						
Dynamic Input	$I_{DDI(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Dynamic Output	$I_{DDO(D)}$		0.01		mA/Mbps	Inputs switching, 50% duty cycle
Undervoltage Lockout	UVLO					
Positive V_{DDx} Threshold	V_{DDxUV+}		1.6		V	
Negative V_{DDx} Threshold	V_{DDxUV-}		1.5		V	
V_{DDx} Hysteresis	V_{DDxUVH}		0.1		V	
AC SPECIFICATIONS						
Output Rise/Fall Time	t_R/t_F		2.5		ns	10% to 90%
Common-Mode Transient Immunity ⁷	$ CM_H $	75	100		kV/ μ s	$V_{IX} = V_{DDx}$, $V_{CM} = 1000$ V, transient magnitude = 800 V
	$ CM_L $	75	100		kV/ μ s	$V_{IX} = 0$ V, $V_{CM} = 1000$ V, transient magnitude = 800 V

¹ 150 Mbps is the highest data rate that can be guaranteed, although higher data rates are possible.

² I_{Ox} is the Channel x output current, where x = A, B, C, or D.

³ V_{IH} is the input side logic high.

⁴ V_{IL} is the input side logic low.

⁵ V_I is the voltage input.

⁶ E0 is the ADuM140E0/ADuM141E0/ADuM142E0 models, D0 is the ADuM140D0/ADuM141D0/ADuM142D0 models, E1 is the ADuM140E1/ADuM141E1/ADuM142E1 models, and D1 is the ADuM140D1/ADuM141D1/ADuM142D1 models. See the Ordering Guide section.

⁷ $|CM_H|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 V_{DDx}$. $|CM_L|$ is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_O > 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

Table 8. Total Supply Current vs. Data Throughput

Parameter	Symbol	1 Mbps			25 Mbps			100 Mbps			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
SUPPLY CURRENT											
ADuM140D/ADuM140E											
Supply Current Side 1	I_{DD1}		6.4	9.8		7.2	11		10.2	15.2	mA
Supply Current Side 2	I_{DD2}		1.9	3.5		3.1	5.0		6.8	10	mA
ADuM141D/ADuM141E											
Supply Current Side 1	I_{DD1}		5.5	9.1		6.3	10.0		9.6	14.0	mA
Supply Current Side 2	I_{DD2}		3.72	6.45		4.8	7.5		8.4	11.2	mA
ADuM142D/ADuM142E											
Supply Current Side 1	I_{DD1}		4.3	7.7		5.3	8.7		8.6	12.6	mA
Supply Current Side 2	I_{DD2}		4.9	8.3		6.0	9.4		9.3	13.3	mA

INSULATION AND SAFETY RELATED SPECIFICATIONS

For additional information, see www.analog.com/icouplersafety.

Table 9. R-16 Narrow Body [SOIC_N] Package

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		3000	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L (I01)	4.0	mm min	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L (I02)	4.0	mm min	Measured from input terminals to output terminals, shortest distance path along body
Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance)	L (PCB)	4.5	mm min	Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane
Minimum Internal Gap (Internal Clearance)		25.5	μm min	Minimum distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		Material Group (DIN VDE 0110, 1/89, Table 1)

Table 10. RW-16 Wide Body [SOIC_W] Package

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		3750	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L (I01)	7.8	mm min	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L (I02)	7.8	mm min	Measured from input terminals to output terminals, shortest distance path along body
Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance)	L (PCB)	8.3	mm min	Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane
Minimum Internal Gap (Internal Clearance)		25.5	μm min	Minimum distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		Material Group (DIN VDE 0110, 1/89, Table 1)

Table 11. RQ-16 [QSOP] Package

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		3000	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L (I01)	3.2	mm min	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L (I02)	3.2	mm min	Measured from input terminals to output terminals, shortest distance path along body
Minimum Clearance in the Plane of the Printed Circuit Board (PCB Clearance)	L (PCB)	3.8	mm min	Measured from input terminals to output terminals, shortest distance through air, line of sight, in the PCB mounting plane
Minimum Internal Gap (Internal Clearance)		25.5	μm min	Minimum distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Material Group		II		Material Group (DIN VDE 0110, 1/89, Table 1)

PACKAGE CHARACTERISTICS**Table 12.**

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Resistance (Input to Output) ¹	R _{I-O}		10 ¹³		Ω	
Capacitance (Input to Output) ¹	C _{I-O}		2.2		pF	f = 1 MHz
Input Capacitance ²	C _I		4.0		pF	
IC Junction to Ambient Thermal Resistance						
R-16 Narrow Body [SOIC_N] Package	θ _{JA}		76		°C/W	Thermocouple located at center of package underside
RW-16 Wide Body [SOIC_W] Package	θ _{JA}		45		°C/W	Thermocouple located at center of package underside
RQ-16 [QSOP] Package	θ _{JA}		76		°C/W	Thermocouple located at center of package underside

¹ The device is considered a 2-terminal device: Pin 1 through Pin 8 are shorted together, and Pin 9 through Pin 16 are shorted together.

² Input capacitance is from any input data pin to ground.

REGULATORY INFORMATION

See Table 21 for the SOIC_N package or Table 22 for the SOIC_W package and the Insulation Lifetime section for details regarding recommended maximum working voltages for specific cross isolation waveforms and insulation levels.

Table 13. R-16 Narrow Body [SOIC_N] Package

UL	CSA	VDE	CQC
Recognized Under UL 1577 Component Recognition Program ¹ Single Protection, 3000 V rms Isolation Voltage File E214100	Approved under CSA Component Acceptance Notice 5A CSA 60950-1-07+A1+A2 and IEC 60950-1, second edition, +A1+A2: Basic insulation at 400 V rms (565 V peak) Reinforced insulation at 200 V rms (283 V peak) IEC 60601-1 Edition 3.1: Basic insulation (one means of patient protection (1 MOPP)), 250 V rms (354 V peak) CSA 61010-1-12 and IEC 61010-1 third edition: Basic insulation at 300 V rms mains, 400 V rms secondary (565 V peak) Reinforced insulation at 300 V rms mains, 200 V secondary (282 V peak) File 205078	Certified according to DIN V VDE V 0884-11 (VDE V 0884-11):2017-01 ² Reinforced insulation, $V_{IORM} = 565$ V peak, $V_{IOSM} = 6000$ V peak Basic insulation, $V_{IORM} = 565$ V peak, $V_{IOSM} = 10$ kV peak File 2471900-4880-0001	Certified under CQC11-471543-2012 GB4943.1-2011: Basic insulation at 770 V rms (1089 V peak) Reinforced insulation at 385 V rms (545 V peak) File CQC16001147385

¹ In accordance with UL 1577, each ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E in the R-16 narrow body [SOIC_N] package is proof tested by applying an insulation test voltage ≥ 3600 V rms for 1 sec.

² In accordance with DIN V VDE V 0884-11, each ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E in the R-16 narrow body [SOIC_N] package is proof tested by applying an insulation test voltage ≥ 1059 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN V VDE V 0884-11 approval.

Table 14. RW-16 Wide Body [SOIC_W] Package

UL	CSA	VDE	CQC
Recognized Under UL 1577 Component Recognition Program ¹ Single Protection, 3750 V rms Isolation Voltage File E214100	Approved under CSA Component Acceptance Notice 5A CSA 60950-1-07+A1+A2 and IEC 60950-1, second edition, +A1+A2: Basic insulation at 780 V rms (1103 V peak) Reinforced insulation at 390 V rms (552 V peak) IEC 60601-1 Edition 3.1: Basic insulation (1 means of patient protection (MOPP)), 490 V rms (693 V peak) CSA 61010-1-12 and IEC 61010-1 third edition: Basic insulation at 300 V rms mains, 780 V secondary (1103 V peak) Reinforced insulation at 300 V rms mains, 390 V secondary (552 V peak) File 205078	Certified according to DIN V VDE V 0884-11 (VDE V 0884-11):2017-01 ² Reinforced insulation, $V_{IORM} = 849$ V peak, $V_{IOSM} = 6000$ V peak Basic insulation, $V_{IORM} = 849$ V peak, $V_{IOSM} = 10$ kV peak File 2471900-4880-0001	Certified under CQC11-471543-2012 GB4943.1-2011: Basic insulation at 780 V rms (1103 V peak) Reinforced insulation at 390 V rms (552 V peak) File CQC16001147385

¹ In accordance with UL 1577, each ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E in the RW-16 wide body [SOIC_W] package is proof tested by applying an insulation test voltage ≥ 4500 V rms for 1 sec.

² In accordance with DIN V VDE V 0884-11, each ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E in the RW-16 wide body [SOIC_W] package is proof tested by applying an insulation test voltage ≥ 1592 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN V VDE V 0884-11 approval.

Table 15. RQ-16 [QSOP] Package

UL	CSA	VDE	CQC
Recognized Under UL 1577 Component Recognition Program ¹	Approved under CSA Component Acceptance Notice 5A	Certified according to DIN V VDE V 0884-11 (VDE V 0884-11):2017-01 ²	Certified under CQC11-471543-2012
Single Protection, 3000 V rms Isolation Voltage	CSA 60950-1-07+A1+A2 and IEC 60950-1, second edition, +A1+A2: Basic insulation at 320 V rms (450 V peak) Reinforced insulation at 160 V rms (225 V peak) IEC 60601-1 Edition 3.1: Basic insulation (1MOPP), 250 V rms (354 V peak) CSA 61010-1-12 and IEC 61010-1 third edition: Basic insulation at 300V rms mains, 320 V rms (450 V peak) Reinforced insulation at 150 V rms mains, 160 V rms (225 V peak) secondary	Reinforced insulation, 636 V peak, VIOSM = 6 kV peak Basic insulation 636 V peak, VIOSM = 10 kV peak	GB4943.1-2011: Basic insulation at 320 V rms (450 V peak) Reinforced insulation at 160Vrms (225 Vpeak)
File E214100	File 205078	File 2471900-4880-0001	File CQC18001192421

¹ In accordance with UL 1577, each ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E in the RQ-16 [QSOP] package is proof tested by applying an insulation test voltage ≥ 3600 V rms for 1 sec.

² In accordance with DIN V VDE V 0884-11, each ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E in the RQ-16 [QSOP] package is proof tested by applying an insulation test voltage ≥ 1059 V peak for 1 sec (partial discharge detection limit = 5 pC). The * marking branded on the component designates DIN V VDE V 0884-11 approval.

DIN V VDE V 0884-11 (VDE V 0884-11) INSULATION CHARACTERISTICS

These isolators are suitable for reinforced electrical isolation only within the safety limit data. Protective circuits ensure the maintenance of the safety data. The * marking on packages denotes DIN V VDE V 0884-11 approval.

Table 16. R-16 Narrow Body [SOIC_N] Package

Description	Test Conditions/Comments	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110 For Rated Mains Voltage ≤ 150 V rms For Rated Mains Voltage ≤ 300 V rms For Rated Mains Voltage ≤ 600 V rms			I to IV I to IV I to III	
Climatic Classification			40/125/21	
Pollution Degree per DIN VDE 0110, Table 1			2	
Maximum Working Insulation Voltage		V_{IORM}	565	V peak
Input to Output Test Voltage, Method B1	$V_{IORM} \times 1.875 = V_{pd(m)}$, 100% production test, $t_{ini} = t_m = 1$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1059	V peak
Input to Output Test Voltage, Method A After Environmental Tests Subgroup 1	$V_{IORM} \times 1.5 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC	$V_{pd(m)}$	848	V peak
After Input and/or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC		678	V peak
Highest Allowable Overvoltage		V_{IOTM}	4200	V peak
Surge Isolation Voltage Basic	V peak = 10 kV, 1.2 μ s rise time, 50 μ s, 50% fall time	V_{IOSM}	10000	V peak
Surge Isolation Voltage Reinforced	V peak = 10 kV, 1.2 μ s rise time, 50 μ s, 50% fall time	V_{IOSM}	6000	V peak
Safety Limiting Values per VDE certification	Maximum value allowed in the event of a failure (see Figure 4)			
Maximum Junction Temperature		T_s	150	$^{\circ}$ C
Total Power Dissipation at 25 $^{\circ}$ C		P_s	1.64	W
Insulation Resistance at T_s	$V_{IO} = 500$ V	R_s	$>10^9$	Ω

Table 17. RW-16 Wide Body [SOIC_W] Package

Description	Test Conditions/Comments	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110 For Rated Mains Voltage ≤ 150 V rms For Rated Mains Voltage ≤ 300 V rms For Rated Mains Voltage ≤ 600 V rms			I to IV I to IV I to IV	
Climatic Classification			40/125/21	
Pollution Degree per DIN VDE 0110, Table 1			2	
Maximum Working Insulation Voltage		V_{IORM}	849	V peak
Input to Output Test Voltage, Method B1	$V_{IORM} \times 1.875 = V_{pd(m)}$, 100% production test, $t_{ini} = t_m = 1$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1592	V peak
Input to Output Test Voltage, Method A		$V_{pd(m)}$		
After Environmental Tests Subgroup 1	$V_{IORM} \times 1.5 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC		1274	V peak
After Input and/or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC		1019	V peak
Highest Allowable Overvoltage		V_{IOTM}	7000	V peak
Surge Isolation Voltage Basic	V peak = 12.8 kV, 1.2 μs rise time, 50 μs, 50% fall time	V_{IOSM}	12000	V peak
Surge Isolation Voltage Reinforced	V peak = 12.8 kV, 1.2 μs rise time, 50 μs, 50% fall time	V_{IOSM}	8000	V peak
Safety Limiting Values per VDE certification	Maximum value allowed in the event of a failure (see Figure 5)			
Maximum Junction Temperature		T_S	150	°C
Total Power Dissipation at 25°C		P_S	2.78	W
Insulation Resistance at T_S	$V_{IO} = 500$ V	R_S	>10 ⁹	Ω

Table 18. RQ-16 [QSOP] Package

Description	Test Conditions/Comments	Symbol	Characteristic	Unit
Installation Classification per DIN VDE 0110 For Rated Mains Voltage ≤ 150 V rms For Rated Mains Voltage ≤ 300 V rms For Rated Mains Voltage ≤ 600 V rms			I to IV I to IV I to IV	
Climatic Classification			40/125/21	
Pollution Degree per DIN VDE 0110, Table 1			2	
Maximum Working Insulation Voltage		V_{IORM}	565	V peak
Input to Output Test Voltage, Method B1	$V_{IORM} \times 1.875 = V_{pd(m)}$, 100% production test, $t_{ini} = t_m = 1$ sec, partial discharge < 5 pC	$V_{pd(m)}$	1059	V peak
Input to Output Test Voltage, Method A		$V_{pd(m)}$		
After Environmental Tests Subgroup 1	$V_{IORM} \times 1.5 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC		848	V peak
After Input and/or Safety Test Subgroup 2 and Subgroup 3	$V_{IORM} \times 1.2 = V_{pd(m)}$, $t_{ini} = 60$ sec, $t_m = 10$ sec, partial discharge < 5 pC		678	V peak
Highest Allowable Overvoltage		V_{IOTM}	4242	V peak
Surge Isolation Voltage Basic	V peak = 10 kV, 1.2 μs rise time, 50 μs, 50% fall time	V_{IOSM}	10000	V peak
Surge Isolation Voltage Reinforced	V peak = 10 kV, 1.2 μs rise time, 50 μs, 50% fall time	V_{IOSM}	6000	V peak
Safety Limiting Values per VDE certification	Maximum value allowed in the event of a failure (see Figure 5)			
Maximum Junction Temperature		T_S	150	°C
Total Power Dissipation at 25°C		P_S	1.64	W
Insulation Resistance at T_S	$V_{IO} = 500$ V	R_S	>10 ⁹	Ω



Figure 4. Thermal Derating Curve for R-16 Narrow Body [SOIC_N] Package, Dependence of Safety Limiting Values with Ambient Temperature per DIN V VDE V 0884-11



Figure 6. Thermal Derating Curve for RQ-16 [QSOP] Package, Dependence of Safety Limiting Values with Ambient Temperature



Figure 5. Thermal Derating Curve for RW-16 Wide Body [SOIC_W] Package, Dependence of Safety Limiting Values with Ambient Temperature per DIN V VDE V 0884-11

RECOMMENDED OPERATING CONDITIONS

Table 19.

Parameter	Symbol	Rating
Operating Temperature	T _A	-40°C to +125°C
Supply Voltages	V _{DD1} , V _{DD2}	1.7 V to 5.5 V
Input Signal Rise and Fall Times		1.0 ms

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 20.

Parameter	Rating
Storage Temperature (T _{ST}) Range	–65°C to +150°C
Ambient Operating Temperature (T _A) Range	–40°C to +125°C
Maximum Fault Junction Temperature (T _J) per DIN V VDE V 0884-11	150°C
Maximum Fault Junction Temperature (T _J) per Mold Compound	300°C
Supply Voltages (V _{DD1} , V _{DD2})	–0.5 V to +7.0 V
Input Voltages (V _{IA} , V _{IB} , V _{IC} , V _{ID} , V _{E1} , V _{E2} , DISABLE ₁ , DISABLE ₂)	–0.5 V to V _{DD1} ¹ + 0.5 V
Output Voltages (V _{OA} , V _{OB} , V _{OC} , V _{OD})	–0.5 V to V _{DDO} ² + 0.5 V
Average Output Current per Pin ³	
Side 1 Output Current (I _{O1})	–10 mA to +10 mA
Side 2 Output Current (I _{O2})	–10 mA to +10 mA
Common-Mode Transients ⁴	–150 kV/μs to +150 kV/μs

¹ V_{DD1} is the input side supply voltage.

² V_{DDO} is the output side supply voltage.

³ See Figure 4 for the R-16 narrow body [SOIC_N] package, Figure 5 for the RW-16 wide body [SOIC_W] package, or Figure 6 for the RQ-16 [QSOP] package for the maximum rated current values at various temperatures.

⁴ Refers to the common-mode transients across the insulation barrier. Common-mode transients exceeding the absolute maximum ratings may cause latch-up or permanent damage.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Table 21. Maximum Continuous Working Voltage R-16 Narrow Body [SOIC_N] Package¹

Parameter	Rating	Constraint ²
AC Voltage		
Bipolar Waveform		
Basic Insulation	789 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	403 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Unipolar Waveform		
Basic Insulation	909 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	469 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
DC Voltage		
Basic Insulation	558 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	285V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1

¹ Refers to the continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

² Insulation lifetime for the specified test condition is greater than 50 years.

Table 22. Maximum Continuous Working Voltage RW-16 Wide Body [SOIC_W] Package¹

Parameter	Rating	Constraint ²
AC Voltage		
Bipolar Waveform		
Basic Insulation	849 V peak	50-year minimum insulation lifetime
Reinforced Insulation	768 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1

Parameter	Rating	Constraint ²
Unipolar Waveform		
Basic Insulation	1698 V peak	50-year minimum insulation lifetime
Reinforced Insulation	885 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
DC Voltage		
Basic Insulation	1092 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	543 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1

¹ Refers to the continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

² Insulation lifetime for the specified test condition is greater than 50 years.

Table 23. Maximum Continuous Working Voltage RQ-16 [QSOP] Package¹

Parameter	Rating	Constraint ²
AC Voltage		
Bipolar Waveform		
Basic Insulation	636 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	318 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Unipolar Waveform		
Basic Insulation	734 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	367 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
DC Voltage		
Basic Insulation	450 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	225 V peak	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1

¹ Refers to the continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

² Insulation lifetime for the specified test condition is greater than 50 years.

TRUTH TABLES

Table 24. ADuM140D/ADuM141D/ADuM142D Truth Table (Positive Logic)

V _{ix} Input ^{1,2}	V _{DISABLEx} Input ^{1,2}	V _{DDI} State ²	V _{DDO} State ²	Default Low (D0), V _{Ox} Output ^{1,2,3}	Default High (D1), V _{Ox} Output ^{1,2,3}	Test Conditions/Comments
L	L or NC	Powered	Powered	L	L	Normal operation
H	L or NC	Powered	Powered	H	H	Normal operation
X	H	Powered	Powered	L	H	Inputs disabled, fail-safe output
X ⁴	X ⁴	Unpowered	Powered	L	H	Fail-safe output
X ⁴	X ⁴	Powered	Unpowered	Indeterminate	Indeterminate	

¹ L means low, H means high, X means don't care, and NC means not connected.

² V_{ix} and V_{Ox} refer to the input and output signals of a given channel (A, B, C, or D). V_{DISABLEx} refers to the input disable signal on the same side as the V_{ix} inputs. V_{DDI} and V_{DDO} refer to the supply voltages on the input and output sides of the given channel, respectively.

³ D0 is the ADuM140D0/ADuM141D0/ADuM142D0 models, and D1 is the ADuM140D1/ADuM141D1/ADuM142D1 models. See the Ordering Guide section.

⁴ Input pins (V_{ix}, DISABLE₁, and DISABLE₂) on the same side as an unpowered supply must be in a low state to avoid powering the device through its ESD protection circuitry.

Table 25. ADuM140E/ADuM141E/ADuM142E Truth Table (Positive Logic)

V _{ix} Input ^{1,2}	V _{Ex} Input ^{1,2}	V _{DDI} State ²	V _{DDO} State ²	Default Low (E0), V _{Ox} Output ^{1,2,3}	Default High (E1), V _{Ox} Output ^{1,2,3}	Test Conditions/Comments
L	H or NC	Powered	Powered	L	L	Normal operation
H	H or NC	Powered	Powered	H	H	Normal operation
X	L	Powered	Powered	Z	Z	Outputs disabled
L	H or NC	Unpowered	Powered	L	H	Fail-safe output
X ⁴	L ⁴	Unpowered	Powered	Z	Z	Outputs disabled
X ⁴	X ⁴	Powered	Unpowered	Indeterminate	Indeterminate	

¹ L means low, H means high, X means don't care, NC means not connected, and Z means high impedance.

² V_{ix} and V_{Ox} refer to the input and output signals of a given channel (A, B, C, or D). V_{Ex} refers to the output enable signal on the same side as the V_{Ox} outputs. V_{DDI} and V_{DDO} refer to the supply voltages on the input and output sides of the given channel, respectively.

³ E0 is the ADuM140E0/ADuM141E0/ADuM142E0 models, and E1 is the ADuM140E1/ADuM141E1/ADuM142E1 models. See the Ordering Guide section.

⁴ Input pins (V_{ix}, VE₁, and VE₂) on the same side as an unpowered supply must be in a low state to avoid powering the device through its ESD protection circuitry.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

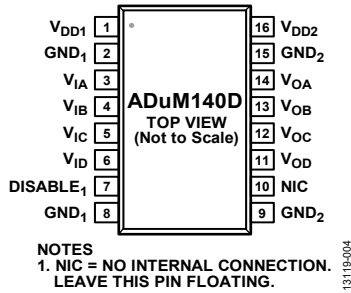


Figure 7. ADuM140D Pin Configuration



Figure 8. ADuM140E Pin Configuration

Table 26. Pin Function Descriptions

Pin No. ¹		Mnemonic	Description
ADuM140D	ADuM140E		
1	1	V _{DD1}	Supply Voltage for Isolator Side 1.
2, 8	2, 8	GND ₁	Ground Reference for Isolator Side 1.
3	3	V _{IA}	Logic Input A.
4	4	V _{IB}	Logic Input B.
5	5	V _{IC}	Logic Input C.
6	6	V _{ID}	Logic Input D.
7	Not applicable	DISABLE ₁	Input Disable 1. This pin disables the isolator inputs. Outputs take on the logic state determined by the fail-safe option shown in the Ordering Guide.
9, 15	9, 15	GND ₂	Ground Reference for Isolator Side 2.
10	7	NIC	No Internal Connection. Leave this pin floating.
Not applicable	10	V _{E2}	Output Enable 2. Active high logic input. When V _{E2} is high or disconnected, the V _{OA} , V _{OB} , V _{OC} , and V _{OD} outputs are enabled. When V _{E2} is low, the V _{OA} , V _{OB} , V _{OC} , and V _{OD} outputs are disabled to the high-Z state.
11	11	V _{OD}	Logic Output D.
12	12	V _{OC}	Logic Output C.
13	13	V _{OB}	Logic Output B.
14	14	V _{OA}	Logic Output A.
16	16	V _{DD2}	Supply Voltage for Isolator Side 2.

¹ Reference the AN-1109 Application Note for specific layout guidelines.



Figure 9. ADuM141D Pin Configuration



Figure 10. ADuM141E Pin Configuration

Table 27. Pin Function Descriptions

Pin No. ¹		Mnemonic	Description
ADuM141D	ADuM141E		
1	1	V _{DD1}	Supply Voltage for Isolator Side 1.
2, 8	2, 8	GND ₁	Ground Reference for Isolator Side 1.
3	3	V _{IA}	Logic Input A.
4	4	V _{IB}	Logic Input B.
5	5	V _{IC}	Logic Input C.
6	6	V _{OD}	Logic Output D.
7	Not applicable	DISABLE ₁	Input Disable 1. This pin disables the isolator inputs. Outputs take on the logic state determined by the fail-safe option shown in the Ordering Guide.
Not applicable	7	V _{E1}	Output Enable 1. Active high logic input. When V _{E1} is high or disconnected, the V _{OD} output is enabled. When V _{E1} is low, the V _{OD} output is disabled to the high-Z state.
9, 15	9, 15	GND ₂	Ground Reference for Isolator Side 2.
10	Not applicable	DISABLE ₂	Input Disable 2. This pin disables the isolator inputs. Outputs take on the logic state determined by the fail-safe option shown in the Ordering Guide.
Not applicable	10	V _{E2}	Output Enable 2. Active high logic input. When V _{E2} is high or disconnected, the V _{OA} , V _{OB} , and V _{OC} outputs are enabled. When V _{E2} is low, the V _{OA} , V _{OB} , and V _{OC} outputs are disabled to the high-Z state.
11	11	V _{ID}	Logic Input D.
12	12	V _{OC}	Logic Output C.
13	13	V _{OB}	Logic Output B.
14	14	V _{OA}	Logic Output A.
16	16	V _{DD2}	Supply Voltage for Isolator Side 2.

¹ Reference the AN-1109 Application Note for specific layout guidelines.



Figure 11. ADuM142D Pin Configuration



Figure 12. ADuM142E Pin Configuration

Table 28. Pin Function Descriptions

Pin No. ¹		Mnemonic	Description
ADuM142D	ADuM142E		
1	1	VDD1	Supply Voltage for Isolator Side 1.
2, 8	2, 8	GND ₁	Ground Reference for Isolator Side 1.
3	3	V _{IA}	Logic Input A.
4	4	V _{IB}	Logic Input B.
5	5	V _{OC}	Logic Output C.
6	6	V _{OD}	Logic Output D.
7	Not applicable	DISABLE ₁	Input Disable 1. This pin disables the isolator inputs. Outputs take on the logic state determined by the fail-safe option shown in the Ordering Guide.
Not applicable	7	V _{E1}	Output Enable 1. Active high logic input. When V _{E1} is high or disconnected, the V _{OC} and V _{OD} outputs are enabled. When V _{E1} is low, the V _{OC} and V _{OD} outputs are disabled to the high-Z state.
9, 15	9, 15	GND ₂	Ground Reference for Isolator Side 2.
10	Not applicable	DISABLE ₂	Input Disable 2. This pin disables the isolator inputs. Outputs take on the logic state determined by the fail-safe option shown in the Ordering Guide.
Not applicable	10	V _{E2}	Output Enable 2. Active high logic input. When V _{E2} is high or disconnected, the V _{OA} and V _{OB} outputs are enabled. When V _{E2} is low, the V _{OA} and V _{OB} outputs are disabled to the high-Z state.
11	11	V _{ID}	Logic Input D.
12	12	V _{IC}	Logic Input C.
13	13	V _{OB}	Logic Output B.
14	14	V _{OA}	Logic Output A.
16	16	VDD ₂	Supply Voltage for Isolator Side 2.

¹ Reference the AN-1109 Application Note for specific layout guidelines.

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 13. ADuM140D/ADuM140E I_{DD1} Supply Current vs. Data Rate at Various Voltages



Figure 16. ADuM141D/ADuM141E I_{DD2} Supply Current vs. Data Rate at Various Voltages



Figure 14. ADuM140D/ADuM140E I_{DD2} Supply Current vs. Data Rate at Various Voltages



Figure 17. ADuM142D/ADuM142E I_{DD1} Supply Current vs. Data Rate at Various Voltages

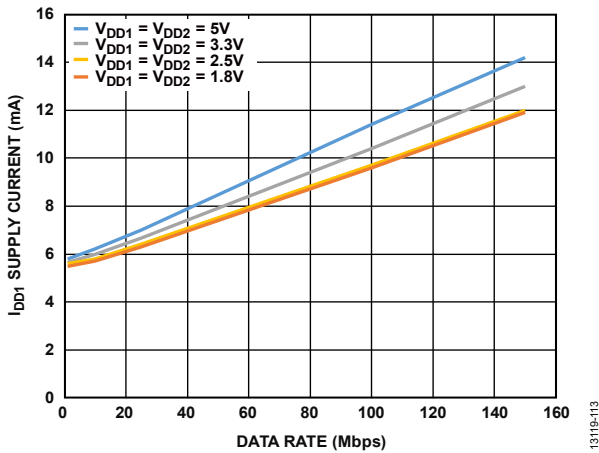


Figure 15. ADuM141D/ADuM141E I_{DD1} Supply Current vs. Data Rate at Various Voltages



Figure 18. ADuM142D/ADuM142E I_{DD2} Supply Current vs. Data Rate at Various Voltages



Figure 19. Propagation Delay, t_{PHL} vs. Temperature at Various Voltages

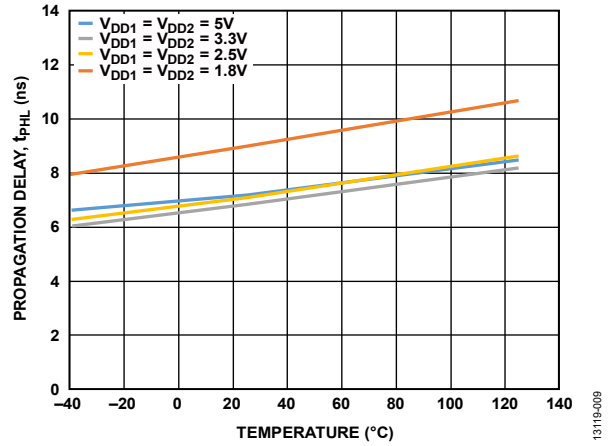


Figure 20. Propagation Delay, t_{PHL} vs. Temperature at Various Voltages

APPLICATIONS INFORMATION

OVERVIEW

The ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E use a high frequency carrier to transmit data across the isolation barrier using *i*Coupler chip scale transformer coils separated by layers of polyimide isolation. Using an on/off keying (OOK) technique and the differential architecture shown in Figure 22 and Figure 23, the ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E have very low propagation delay and high speed. Internal regulators and input/output design techniques allow logic and supply voltages over a wide range from 1.7 V to 5.5 V, offering voltage translation of 1.8 V, 2.5 V, 3.3 V, and 5 V logic. The architecture is designed for high common-mode transient immunity and high immunity to electrical noise and magnetic interference. Radiated emissions are minimized with a spread spectrum OOK carrier and other techniques.

Figure 22 illustrates the waveforms for models of the ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E that have the condition of the fail-safe output state equal to low, where the carrier waveform is off when the input state is low. If the input side is off or not operating, the low fail-safe output state (ADuM140D0/ADuM140E0/ADuM141D0/ADuM141E0/ADuM142D0/ADuM142E0) sets the output to low. For the ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E that have a high fail-safe output state, Figure 23 illustrates the conditions where the carrier waveform is off when the input state is high. When the input side is off or not operating, the fail-safe output state of high (ADuM140D1/ADuM140E1/ADuM141D1/ADuM141E1/ADuM142D1/ADuM142E1) sets the output to high. See the Ordering Guide for the model numbers that have the fail-safe output state of low or the fail-safe output state of high.

PRINTED CIRCUIT BOARD (PCB) LAYOUT

The ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E digital isolators require no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 21). Bypass capacitors are most conveniently connected between Pin 1 and Pin 2 for V_{DD1} and between Pin 15 and Pin 16 for V_{DD2} . The recommended bypass capacitor value is between 0.01 μ F and 0.1 μ F. The total lead length between both ends of the capacitor and the input power supply pin must not exceed 10 mm. Bypassing between Pin 1 and Pin 8 and between Pin 9 and Pin 16 must also be considered, unless the ground pair on each package side is connected close to the package.



Figure 21. Recommended Printed Circuit Board Layout

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, design the board layout such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this can cause voltage differentials between pins exceeding the Absolute Maximum Ratings of the device, thereby leading to latch-up or permanent damage.

See the AN-1109 Application Note for board layout guidelines.



Figure 22. Operational Block Diagram of a Single Channel with a Low Fail-Safe Output State



Figure 23. Operational Block Diagram of a Single Channel with a High Fail-Safe Output State

PROPAGATION DELAY RELATED PARAMETERS

Propagation delay is a parameter that describes the time required for a logic signal to propagate through a component. The propagation delay to a Logic 0 output may differ from the propagation delay to a Logic 1 output.



Figure 24. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the timing of the input signal is preserved.

Channel matching is the maximum amount the propagation delay differs between channels within a single ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E component.

Propagation delay skew is the maximum amount the propagation delay that differs between multiple ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E components operating under the same conditions.

JITTER MEASUREMENT

Figure 25 shows the eye diagram for the ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E. The measurement was taken using an Agilent 81110A pulse pattern generator at 150 Mbps with pseudorandom bit sequences (PRBS) $2(n-1)$, $n=14$, for 5 V supplies. Jitter was measured with the Tektronix Model 5104B oscilloscope, 1 GHz, 10 GSPS with the DPOJET jitter and eye diagram analysis tools. The result shows a typical measurement on the ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E with 490 ps p-p jitter.



Figure 25. ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E Eye Diagram

INSULATION LIFETIME

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation as well as on the materials and material interfaces.

The two types of insulation degradation of primary interest are breakdown along surfaces exposed to the air and insulation wear out. Surface breakdown is the phenomenon of surface tracking and the primary determinant of surface creepage requirements in system level standards. Insulation wear out is the phenomenon where charge injection or displacement currents inside the insulation material cause long-term insulation degradation.

Surface Tracking

Surface tracking is addressed in electrical safety standards by setting a minimum surface creepage based on the working voltage, the environmental conditions, and the properties of the insulation material. Safety agencies perform characterization testing on the surface insulation of components that allows the components to be categorized in different material groups. Lower material group ratings are more resistant to surface tracking and, therefore, can provide adequate lifetime with smaller creepage. The minimum creepage for a given working voltage and material group is in each system level standard and is based on the total rms voltage across the isolation, pollution degree, and material group. The material group and creepage for the ADuM140D/ADuM140E/ADuM141D/ADuM141E/ADuM142D/ADuM142E isolators are presented in Table 9 for the R-16 narrow body [SOIC_N] package or Table 10 for the RW-16 wide body [SOIC_W] package.

Insulation Wear Out

The lifetime of insulation caused by wear out is determined by its thickness, material properties, and the voltage stress applied. It is important to verify that the product lifetime is adequate at the application working voltage. The working voltage supported by an isolator for wear out may not be the same as the working voltage supported for tracking. The working voltage applicable to tracking is specified in most standards.

Testing and modeling have shown that the primary driver of long-term degradation is displacement current in the polyimide insulation causing incremental damage. The stress on the insulation can be broken down into broad categories, such as dc stress, which causes very little wear out because there is no displacement current, and an ac component time varying voltage stress, which causes wear out.

The ratings in certification documents are usually based on 60 Hz sinusoidal stress because this reflects isolation from line voltage. However, many practical applications have combinations of 60 Hz ac and dc across the barrier as shown in Equation 1. Because only the ac portion of the stress causes wear out, the equation can be rearranged to solve for the ac rms voltage, as is shown in Equation 2. For insulation wear out with the polyimide materials used in these products, the ac rms voltage determines the product lifetime.

$$V_{RMS} = \sqrt{V_{ACRMS}^2 + V_{DC}^2} \quad (1)$$

or

$$V_{ACRMS} = \sqrt{V_{RMS}^2 - V_{DC}^2} \quad (2)$$

where:

V_{ACRMS} is the time varying portion of the working voltage.

V_{RMS} is the total rms working voltage.

V_{DC} is the dc offset of the working voltage.

Calculation and Use of Parameters Example

The following example frequently arises in power conversion applications. Assume that the line voltage on one side of the isolation is 240 V ac rms and a 400 V dc bus voltage is present on the other side of the isolation barrier. The isolator material is polyimide. To establish the critical voltages in determining the creepage, clearance and lifetime of a device, see Figure 26 and the following equations.



Figure 26. Critical Voltage Example

13119-013

The working voltage across the barrier from Equation 1 is

$$V_{RMS} = \sqrt{V_{ACRMS}^2 + V_{DC}^2}$$

$$V_{RMS} = \sqrt{240^2 + 400^2}$$

$$V_{RMS} = 466 \text{ V}$$

This V_{RMS} value is the working voltage used together with the material group and pollution degree when looking up the creepage required by a system standard.

To determine if the lifetime is adequate, obtain the time varying portion of the working voltage. To obtain the ac rms voltage, use Equation 2.

$$V_{ACRMS} = \sqrt{V_{RMS}^2 - V_{DC}^2}$$

$$V_{ACRMS} = \sqrt{466^2 - 400^2}$$

$$V_{ACRMS} = 240 \text{ V rms}$$

In this case, the ac rms voltage is simply the line voltage of 240 V rms. This calculation is more relevant when the waveform is not sinusoidal. The value is compared to the limits for working voltage in Table 21 for the SOIC_N package or Table 22 for the SOIC_W package, for the expected lifetime, which is less than a 60 Hz sine wave, and it is well within the limit for a 50-year service life.

Note that the dc working voltage limit is set by the creepage of the package as specified in IEC 60664-1. This value can differ for specific system level standards.

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AC
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 27. 16-Lead Standard Small Outline Package [SOIC_N] Narrow Body (R-16)
 Dimensions shown in millimeters and (inches)

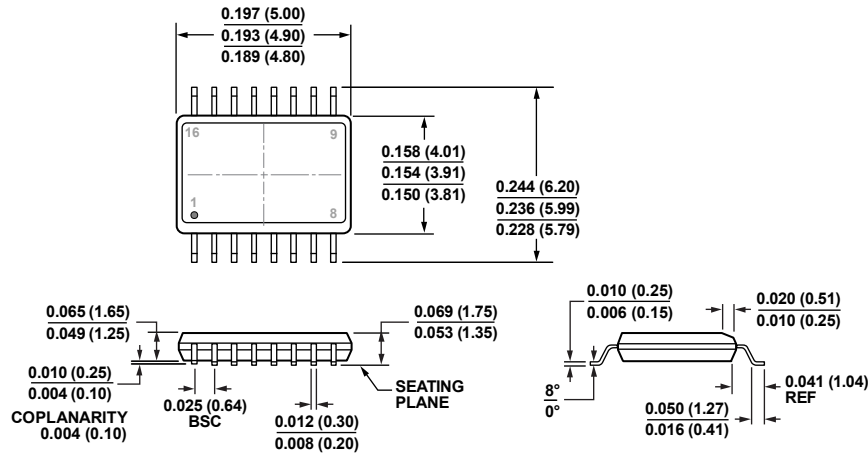
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COMPLIANT TO JEDEC STANDARDS MS-013-AA
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 28. 16-Lead Standard Small Outline Package [SOIC_W] Wide Body (RW-16)
 Dimensions shown in millimeters and (inches)

03-37-2007-B



COMPLIANT TO JEDEC STANDARDS MO-137-AB
 CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS
 (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 29. 16-Lead Shrink Small Outline Package [QSOP]
 (RQ-16)
 Dimensions shown in inches and (millimeters)

09-12-2014-A

ORDERING GUIDE

Model ^{1,2}	Temperature Range	No. of Inputs, V _{DD1} Side	No. of Inputs, V _{DD2} Side	Withstand Voltage Rating (kV rms)	Fail-Safe Output State	Input Disable	Output Enable	Package Description	Package Option
ADuM140D1BRZ	-40°C to +125°C	4	0	3.0	High	Yes	No	16-Lead SOIC_N	R-16
ADuM140D1BRZ-RL7	-40°C to +125°C	4	0	3.0	High	Yes	No	16-Lead SOIC_N	R-16
ADuM140DOBZ	-40°C to +125°C	4	0	3.0	Low	Yes	No	16-Lead SOIC_N	R-16
ADuM140DOBZ-RL7	-40°C to +125°C	4	0	3.0	Low	Yes	No	16-Lead SOIC_N	R-16
ADuM140E1BRZ	-40°C to +125°C	4	0	3.0	High	No	Yes	16-Lead SOIC_N	R-16
ADuM140E1BRZ-RL7	-40°C to +125°C	4	0	3.0	High	No	Yes	16-Lead SOIC_N	R-16
ADuM140E0BRZ	-40°C to +125°C	4	0	3.0	Low	No	Yes	16-Lead SOIC_N	R-16
ADuM140E0BRZ-RL7	-40°C to +125°C	4	0	3.0	Low	No	Yes	16-Lead SOIC_N	R-16
ADuM140D1BRWZ	-40°C to +125°C	4	0	3.75	High	Yes	No	16-Lead SOIC_W	RW-16
ADuM140D1BRWZ-RL	-40°C to +125°C	4	0	3.75	High	Yes	No	16-Lead SOIC_W	RW-16
ADuM140DOBWZ	-40°C to +125°C	4	0	3.75	Low	Yes	No	16-Lead SOIC_W	RW-16
ADuM140DOBWZ-RL	-40°C to +125°C	4	0	3.75	Low	Yes	No	16-Lead SOIC_W	RW-16
ADuM140D1BRQZ	-40°C to +125°C	4	0	3.0	High	Yes	No	16-Lead QSOP	RQ-16
ADuM140D1BRQZ-RL7	-40°C to +125°C	4	0	3.0	High	Yes	No	16-Lead QSOP	RQ-16
ADuM140DOBQZ	-40°C to +125°C	4	0	3.0	Low	Yes	No	16-Lead QSOP	RQ-16
ADuM140DOBQZ-RL7	-40°C to +125°C	4	0	3.0	Low	Yes	No	16-Lead QSOP	RQ-16
ADuM140E1BRWZ	-40°C to +125°C	4	0	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM140E1BRWZ-RL	-40°C to +125°C	4	0	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM140E1WBRWZ	-40°C to +125°C	4	0	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM140E1WBRWZ-RL	-40°C to +125°C	4	0	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM140E0BRWZ	-40°C to +125°C	4	0	3.75	Low	No	Yes	16-Lead SOIC_W	RW-16
ADuM140E0BRWZ-RL	-40°C to +125°C	4	0	3.75	Low	No	Yes	16-Lead SOIC_W	RW-16
ADuM140E1BRQZ	-40°C to +125°C	4	0	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM140E1BRQZ-RL7	-40°C to +125°C	4	0	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM140E0BRQZ	-40°C to +125°C	4	0	3.0	Low	No	Yes	16-Lead QSOP	RQ-16
ADuM140E0BRQZ-RL7	-40°C to +125°C	4	0	3.0	Low	No	Yes	16-Lead QSOP	RQ-16

Model ^{1,2}	Temperature Range	No. of Inputs, V _{DD1} Side	No. of Inputs, V _{DD2} Side	Withstand Voltage Rating (kV rms)	Fail-Safe Output State	Input Disable	Output Enable	Package Description	Package Option
ADuM141D1BRZ	-40°C to +125°C	3	1	3.0	High	Yes	No	16-Lead SOIC_N	R-16
ADuM141D1BRZ-RL7	-40°C to +125°C	3	1	3.0	High	Yes	No	16-Lead SOIC_N	R-16
ADuM141D0BRZ	-40°C to +125°C	3	1	3.0	Low	Yes	No	16-Lead SOIC_N	R-16
ADuM141D0BRZ-RL7	-40°C to +125°C	3	1	3.0	Low	Yes	No	16-Lead SOIC_N	R-16
ADuM141E1BRZ	-40°C to +125°C	3	1	3.0	High	No	Yes	16-Lead SOIC_N	R-16
ADuM141E1BRZ-RL7	-40°C to +125°C	3	1	3.0	High	No	Yes	16-Lead SOIC_N	R-16
ADuM141E0BRZ	-40°C to +125°C	3	1	3.0	Low	No	Yes	16-Lead SOIC_N	R-16
ADuM141E0BRZ-RL7	-40°C to +125°C	3	1	3.0	Low	No	Yes	16-Lead SOIC_N	R-16
ADuM141D1BRWZ	-40°C to +125°C	3	1	3.75	High	Yes	No	16-Lead SOIC_W	RW-16
ADuM141D1BRWZ-RL	-40°C to +125°C	3	1	3.75	High	Yes	No	16-Lead SOIC_W	RW-16
ADuM141D0BRWZ	-40°C to +125°C	3	1	3.75	Low	Yes	No	16-Lead SOIC_W	RW-16
ADuM141D0BRWZ-RL	-40°C to +125°C	3	1	3.75	Low	Yes	No	16-Lead SOIC_W	RW-16
ADuM141D1BRQZ	-40°C to +125°C	3	1	3.0	High	Yes	No	16-Lead QSOP	RQ-16
ADuM141D1BRQZ-RL7	-40°C to +125°C	3	1	3.0	High	Yes	No	16-Lead QSOP	RQ-16
ADuM141D0BRQZ	-40°C to +125°C	3	1	3.0	Low	Yes	No	16-Lead QSOP	RQ-16
ADuM141D0BRQZ-RL7	-40°C to +125°C	3	1	3.0	Low	Yes	No	16-Lead QSOP	RQ-16
ADuM141E1BRWZ	-40°C to +125°C	3	1	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM141E1BRWZ-RL	-40°C to +125°C	3	1	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM141E1WBRWZ	-40°C to +125°C	3	1	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM141E1WBRWZ-RL	-40°C to +125°C	3	1	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM141E0BRWZ	-40°C to +125°C	3	1	3.75	Low	No	Yes	16-Lead SOIC_W	RW-16
ADuM141E0BRWZ-RL	-40°C to +125°C	3	1	3.75	Low	No	Yes	16-Lead SOIC_W	RW-16
ADuM141E1BRQZ	-40°C to +125°C	3	1	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM141E1BRQZ-RL7	-40°C to +125°C	3	1	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM141E0BRQZ	-40°C to +125°C	3	1	3.0	Low	No	Yes	16-Lead QSOP	RQ-16
ADuM141E0BRQZ-RL7	-40°C to +125°C	3	1	3.0	Low	No	Yes	16-Lead QSOP	RQ-16
ADuM141E0WBRQZ-RL7	-40°C to +125°C	3	1	3.0	Low	No	Yes	16-Lead QSOP	RQ-16
ADuM141E1WBRQZ	-40°C to +125°C	3	1	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM141E1WBRQZ-RL7	-40°C to +125°C	3	1	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM142D1BRZ	-40°C to +125°C	2	2	3.0	High	Yes	No	16-Lead SOIC_N	R-16
ADuM142D1BRZ-RL7	-40°C to +125°C	2	2	3.0	High	Yes	No	16-Lead SOIC_N	R-16
ADuM142D0BRZ	-40°C to +125°C	2	2	3.0	Low	Yes	No	16-Lead SOIC_N	R-16
ADuM142D0BRZ-RL7	-40°C to +125°C	2	2	3.0	Low	Yes	No	16-Lead SOIC_N	R-16
ADuM142E1BRZ	-40°C to +125°C	2	2	3.0	High	No	Yes	16-Lead SOIC_N	R-16
ADuM142E1BRZ-RL7	-40°C to +125°C	2	2	3.0	High	No	Yes	16-Lead SOIC_N	R-16
ADuM142E0BRZ	-40°C to +125°C	2	2	3.0	Low	No	Yes	16-Lead SOIC_N	R-16
ADuM142E0BRZ-RL7	-40°C to +125°C	2	2	3.0	Low	No	Yes	16-Lead SOIC_N	R-16
ADuM142D1BRWZ	-40°C to +125°C	2	2	3.75	High	Yes	No	16-Lead SOIC_W	RW-16
ADuM142D1BRWZ-RL	-40°C to +125°C	2	2	3.75	High	Yes	No	16-Lead SOIC_W	RW-16
ADuM142D0BRWZ	-40°C to +125°C	2	2	3.75	Low	Yes	No	16-Lead SOIC_W	RW-16
ADuM142D0BRWZ-RL	-40°C to +125°C	2	2	3.75	Low	Yes	No	16-Lead SOIC_W	RW-16
ADuM142D1BRQZ	-40°C to +125°C	2	2	3.0	High	Yes	No	16-Lead QSOP	RQ-16
ADuM142D1BRQZ-RL7	-40°C to +125°C	2	2	3.0	High	Yes	No	16-Lead QSOP	RQ-16
ADuM142D0BRQZ	-40°C to +125°C	2	2	3.0	Low	Yes	No	16-Lead QSOP	RQ-16
ADuM142D0BRQZ-RL7	-40°C to +125°C	2	2	3.0	Low	Yes	No	16-Lead QSOP	RQ-16
ADuM142E1BRWZ	-40°C to +125°C	2	2	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM142E1BRWZ-RL	-40°C to +125°C	2	2	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM142E1WBRWZ	-40°C to +125°C	2	2	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM142E1WBRWZ-RL	-40°C to +125°C	2	2	3.75	High	No	Yes	16-Lead SOIC_W	RW-16
ADuM142E0BRWZ	-40°C to +125°C	2	2	3.75	Low	No	Yes	16-Lead SOIC_W	RW-16
ADuM142E0BRWZ-RL	-40°C to +125°C	2	2	3.75	Low	No	Yes	16-Lead SOIC_W	RW-16
ADuM142E1BRQZ	-40°C to +125°C	2	2	3.0	High	No	Yes	16-Lead QSOP	RQ-16

Model ^{1,2}	Temperature Range	No. of Inputs, V _{DD1} Side	No. of Inputs, V _{DD2} Side	Withstand Voltage Rating (kV rms)	Fail-Safe Output State	Input Disable	Output Enable	Package Description	Package Option
ADuM142E1BRQZ-RL7	-40°C to +125°C	2	2	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM142E0BRQZ	-40°C to +125°C	2	2	3.0	Low	No	Yes	16-Lead QSOP	RQ-16
ADuM142E0BRQZ-RL7	-40°C to +125°C	2	2	3.0	Low	No	Yes	16-Lead QSOP	RQ-16
ADuM142E1WBRQZ	-40°C to +125°C	2	2	3.0	High	No	Yes	16-Lead QSOP	RQ-16
ADuM142E1WBRQZ-RL7	-40°C to +125°C	2	2	3.0	High	No	Yes	16-Lead QSOP	RQ-16

¹ Z = RoHS Compliant Part.

² The ADuM140E1WBRWZ, ADuM140E1WBRWZ-RL, ADuM141E1WBRWZ, ADuM141E1WBRWZ-RL, ADuM141E0WBRQZ-RL7, ADuM141E1WBRQZ, ADuM141E1WBRQZ-RL7, ADuM142E1WBRWZ, ADuM142E1WBRWZ-RL, ADuM142E1WBRQZ, and ADuM142E1WBRQZ-RL7 are qualified for automotive applications.

AUTOMOTIVE PRODUCTS

The [ADuM140E1W](#), [ADuM141E0W](#), [ADuM141E1W](#) and [ADuM142E1W](#) models are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that these automotive models may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

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